# 2SD1996

### Silicon NPN epitaxial planer type

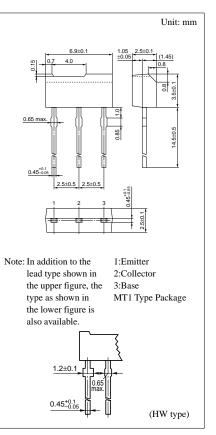
For low-voltage output amplification For muting For DC-DC converter

#### Features

- Low collector to emitter saturation voltage V<sub>CE(sat)</sub>.
- Low ON resistance Ron.
- High foward current transfer ratio h<sub>FE</sub>.
- Allowing supply with the radial taping.

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V <sub>CBO</sub>	25	V
Collector to emitter voltage	V <sub>CEO</sub>	20	V
Emitter to base voltage	V <sub>EBO</sub>	12	V
Peak collector current	I <sub>CP</sub>	1	А
Collector current	I <sub>C</sub>	0.5	А
Collector power dissipation	P <sub>C</sub>	600	mW
Junction temperature	Tj	150	°C
Storage temperature	T <sub>stg</sub>	-55 ~ +150	°C

#### Absolute Maximum Ratings (Ta=25°C)

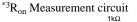


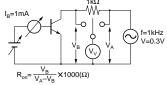
#### Electrical Characteristics (Ta=25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I <sub>CBO</sub>	$V_{CB} = 25V, I_E = 0$			100	nA
Collector to base voltage	V <sub>CBO</sub>	$I_C = 10 \mu A, I_E = 0$	25			V
Collector to emitter voltage	V <sub>CEO</sub>	$I_C = 1 \text{mA}, I_B = 0$	20			V
Emitter to base voltage	V <sub>EBO</sub>	$I_E = 10 \mu A, I_C = 0$	12			V
Forward current transfer ratio	h <sub>FE1</sub> *1	$V_{CE} = 2V, I_C = 0.5A^{*2}$	200		800	
	h <sub>FE2</sub>	$V_{CE} = 2V, I_C = 1A^{*2}$	60			
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 0.5 A, I_{\rm B} = 20 {\rm mA}$		0.13	0.4	V
Base to emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{\rm C} = 0.5 A, I_{\rm B} = 50 {\rm mA}$			1.2	V
Transition frequency	f <sub>T</sub>	$V_{CB} = 10V, I_E = -50mA, f = 200MHz$		200		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10V, I_E = 0, f = 1MHz$		10		pF
ON resistanse	R <sub>on</sub> <sup>*3</sup>			1.0		Ω

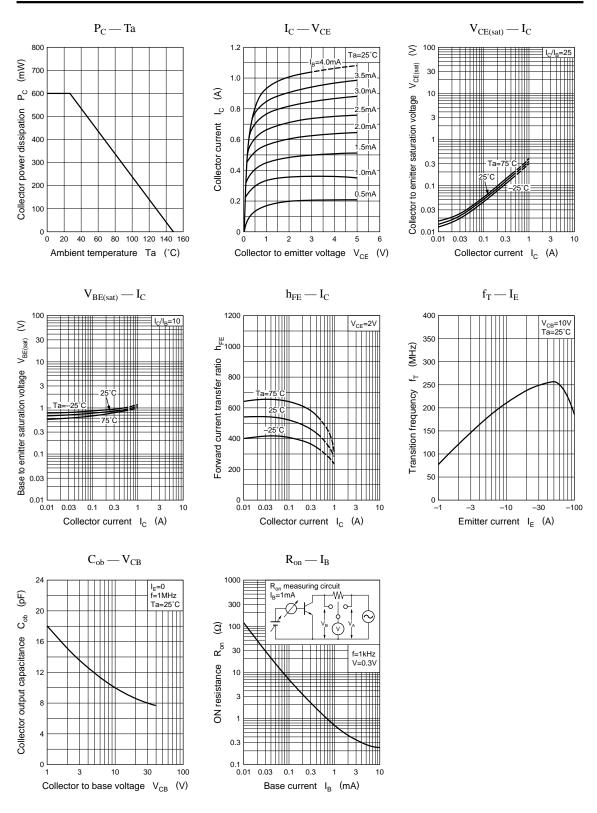
\*1hFE1 Rank classification

Rank	R	S	Т	
h <sub>FE1</sub>	200 ~ 350	300 ~ 500	400 ~ 800	





\*2 Pulse measurement



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